BF256A

BF256A is a Preferred Device

JFET - General Purpose

N-Channel

N-Channel Junction Field Effect Transistor designed for VHF and UHF applications.

- Low Cost TO-92 Type Package
- Forward Transfer Admittance, Y_{fs} = 4.5 mmhos (Min)
- Transfer Capacitance $C_{rss} = 0.7$ (Typ)
- Power Gain at f = 800 MHz, Typ. = 11 dB

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	30	Vdc
Drain-Gate Voltage	V _{DG}	30	Vdc
Gate-Source Voltage	V _{GS}	30	Vdc
Forward Gate Current	I _{G(f)}	10	mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	PD	360 2.88	mW mW/°C
Operating and Storage Channel Temperature Range	T _{channel} , T _{stg}	-65 to +150	°C

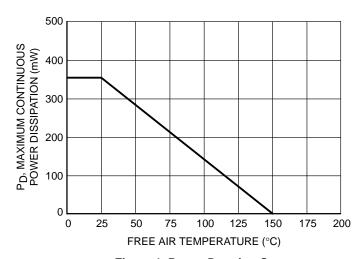
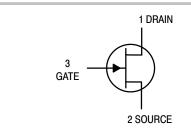


Figure 1. Power Derating Curve



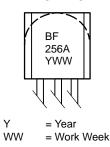
ON Semiconductor™

http://onsemi.com





MARKING DIAGRAMS



ORDERING INFORMATION

Device	Package	Shipping	
BF256A	TO-92	5000 Units/Box	

Preferred devices are recommended choices for future use and best overall value.

BF256A

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					•	
Gate-Source Breakdown Voltage	$(-I_G = -1.0 \mu\text{Adc}, V_{DS} = 0)$	−V(BR)GSS	30	_	_	Vdc
Gate-Source Voltage	$(V_{DS} = 15 \text{ Vdc}, I_{D} = 200 \mu\text{A})$	-V _{GS}	0.5	_	7.5	Vdc
Gate Reverse Current	$(-V_{GS} = 20 \text{ Vdc}, V_{DS} = 0)$	-I _{GSS}	_	_	5.0	nAdc
ON CHARACTERISTICS						
Zero-Gate-Voltage Drain Current (Note 1.) $(V_{DS} = 15 \text{ Vdc}, V_{GS} = 0)$	IDSS	3.0	-	7.0	mAdc
SMALL-SIGNAL CHARACTER	RISTICS	•	•	•	-	•
Forward Transfer Admittance	(V _{DS} = 15 Vdc, V _{GS} = 0, f = 1 kHz)	Y _{fs}	4.5	5.0	_	mmhos
Reverse Transfer Capacitance	$(V_{DS} = 20 \text{ Vdc}, -V_{GS} = 1 \text{ Vdc}, f = 1 \text{ MHz})$	C _{rss}	_	0.7	-	pF
Output Capacitance	$(V_{DS} = 20 \text{ Vdc}, V_{GS} = 0, f = 1 \text{ MHz})$	C _{oss}	_	1.0	-	pF
Cut-Off Frequency (Note 2.)	(V _{DS} = 15 Vdc, V _{GS} = 0)	fgfs	_	1000	_	MHz

^{1.} Pulse Test: Pulse Width = $300 \mu s$, Duty Cycle = 2.0%.

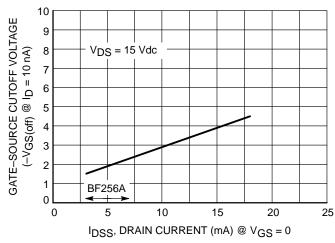


Figure 2. Correlation Between -VGS(off) and IDSS

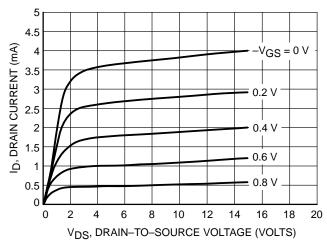


Figure 3. Drain Current versus Drain-to-Source Voltage

^{2.} The frequency at which gfs is 0.7 of its value at 1 KHz.

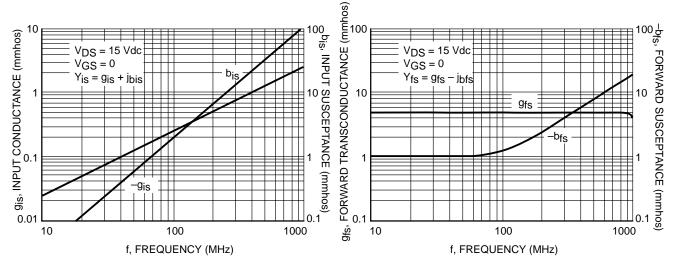


Figure 4. Input Admittance versus Frequency

Figure 5. Forward Transfer Admittance versus Frequency

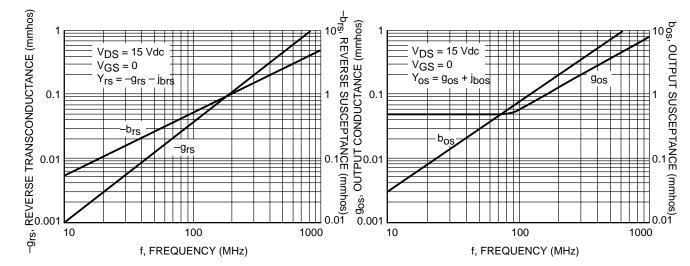


Figure 6. Reverse Transfer Admittance versus Frequency

Figure 7. Output Admittance versus Frequency

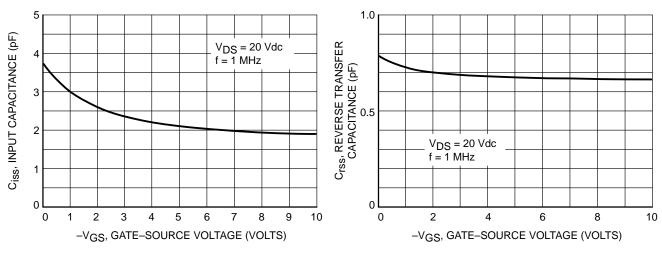


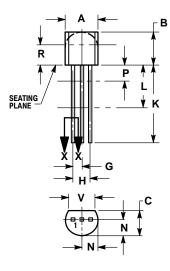
Figure 8. Input Capacitance versus Gate-Source Voltage

Figure 9. Reverse Transfer Capacitance versus Gate-Source Voltage

BF256A

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AL**





- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
C	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
7	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
P		0.100		2.54	
R	0.115		2.93		
٧	0.135		3.43		

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